Product data sheet

1. General description

Hyperfast, epitaxial rectifier diode in a 2-lead TO220F plastic package.

2. Features and benefits

- · Extremely fast switching
- Low thermal resistance
- · Low reverse recovery current
- Isolated package
- · Reduces switching losses in associated MOSFET

3. Applications

- · Half-bridge or full-bridge switched-mode power supplies
- Continuous Current Mode (CCM) Power Factor Correction (PFC)
- Half-bridge lighting ballasts

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Val	lues		Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		600				V
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _h ≤ 25 °C; Fig. 1; Fig. 2	20				А
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _h ≤ 25 °C; square-wave pulse	40			Α	
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	250			Α	
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	274		Α		
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit	
Static ch	aracteristics						
V _F	forward voltage	I _F = 20 A; T _j = 150 °C; <u>Fig. 4</u>	- 1.54 1.97		1.97	V	
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 50 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 5		-	35	55	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode		K — A
mb	n.c.	mounting base; isolated		001aaa020
			SOD113 (2-lead TO-220F)	

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BYC20X-600	TO220F	BYC20X-600, 127	Tube	50	SOD113	28-Aug-2015

7. Marking

Table 4. Marking codes

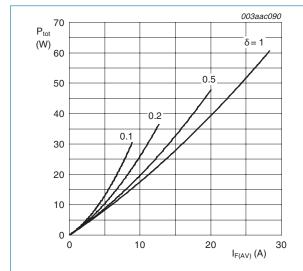
Type number	Marking codes
BYC20X-600	BYC20X 600

8. Limiting values

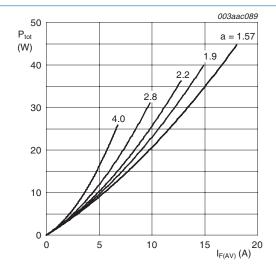
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V_R	reverse voltage	δ = 1; square-wave pulse; $T_h \le 100 ^{\circ}\text{C}$	500	V
I _{F(AV)}	average forward current	$δ$ = 0.5; square-wave pulse; $T_h \le 25$ °C; Fig. 1; Fig. 2	20	А
I _{FRM}	repetitive peak forward current	$δ = 0.5$; $t_p = 25 \mu s$; $T_h \le 25 °C$; square-wave pulse	40	Α
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	250	А
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	274	А
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C



I_{F(AV)} = I_{F(RMS)} × √δ
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



a = form factor = I_{F(RMS)}/I_{F(AV)}
 Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

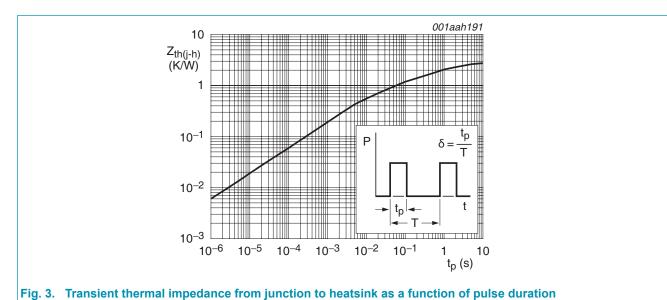
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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	with heatsink compound; Fig. 3	-	-	2.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



10. Isolation characteristics

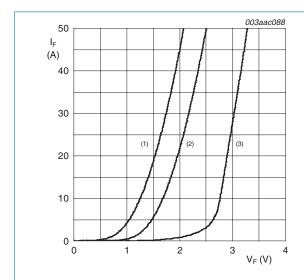
Table 7. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	50 Hz ≤ f ≤ 60 Hz; RH ≤ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	f = 1 MHz; from cathode to external heatsink	-	10	-	pF

11. Characteristics

Table 8. Characteristics

iable o. Ci	iaracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward voltage	I _F = 20 A; T _j = 150 °C; <u>Fig. 4</u>	-	1.54	1.97	V
		I _F = 40 A; T _j = 150 °C; <u>Fig. 4</u>	-	1.95	2.34	V
		I _F = 20 A; <u>Fig. 4</u>		1.89	2.9	V
I _R	reverse current	V _R = 600 V	-	16	200	μA
		V _R = 500 V; T _j = 100 °C	-	1.6	3.0	mA
Dynamic	characteristics					
t _{rr} re\	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 5$	-	35	55	ns
		$I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/µs};$ $T_j = 25 \text{ °C}; Fig. 5$	-	19	-	ns
		$I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/}\mu\text{s};$ $T_j = 100 \text{ °C}; Fig. 5$	-	32	40	ns
I _{RM}	peak reverse recovery current	$I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 5$	-	3	7.5	А
		$I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/µs};$ $T_j = 125 \text{ °C}; Fig. 5$	-	9.5	12	А
V_{FR}	forward recovery voltage	I _F = 20 A; dI _F /dt = 100 A/μs; T _i = 25 °C; <u>Fig. 6</u>	-	8	11	V



(1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values

(3) T_i = 25 °C; maximum values

Fig. 4. Forward current as a function of forward voltage

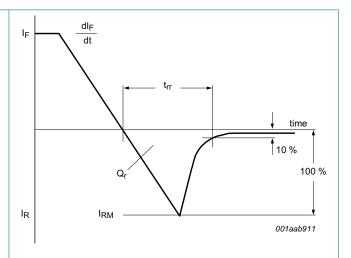
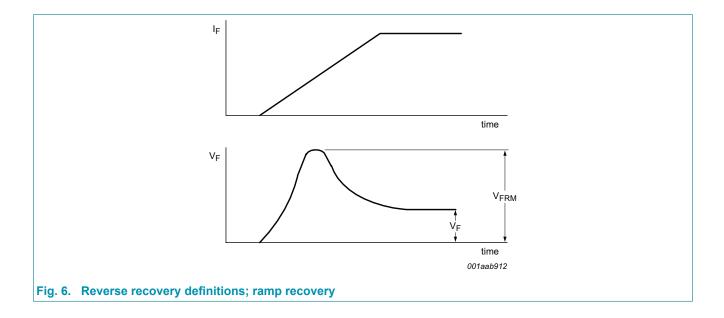


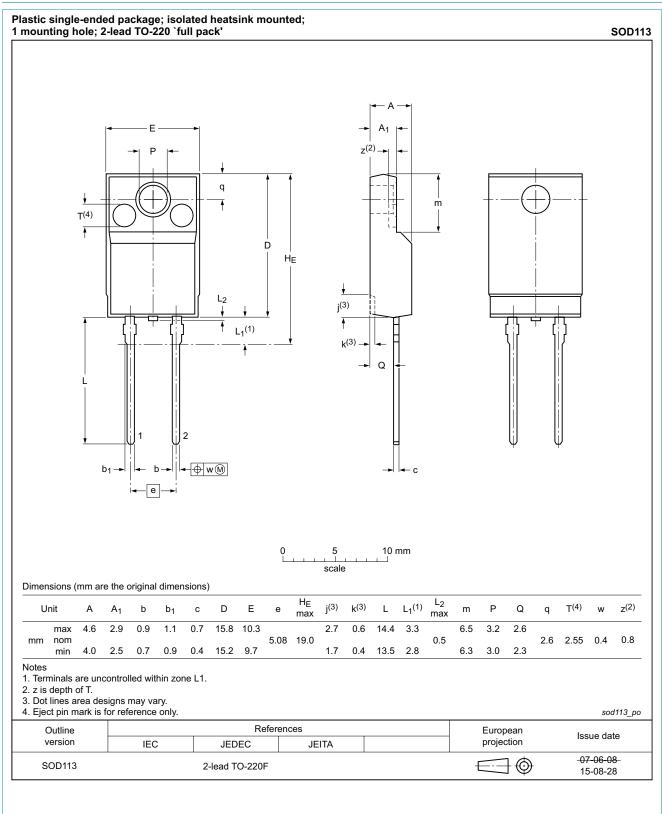
Fig. 5. Reverse recovery definitions; ramp recovery

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12. Package outline



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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- [2] The term 'short data sheet' is explained in section "Definitions".
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